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TITLE : MANUFACTURE OF NON-CONTACT IC TAG AND THE SAME TAG

(a)



(b)



(c)



(d)



(e)



(f)



ABSTRACT : PURPOSE: To manufacture a low-cost non-contact IC tag by reducing the number of manufacturing steps of the tag.

CONSTITUTION: A method for manufacturing a non-contact IC tag comprises the steps of mounting an insert component 20 having a circuit component in molds 76a, 76b, then closing the molds, evacuating in vacuum the mold, then casting liquidlike curable resin raw material such as epoxy resin in the mold, and then curing the material by a low-pressure injection molding method.

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